

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231

Inventor: **Lau, et al.**

Serial No: **Div. of 10/176,335**

Filed: **June 19, 2002**

For: **Compositions and Methods
for Thermosetting Molecules
in Organic Compositions**

Examiner: **D. Truong**

Art Unit: **1711**

PRELIMINARY AMENDMENT

Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

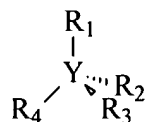
Dear Sir:

Please enter the following preliminary amendment:

IN THE CLAIMS

Please cancel all pending claims and add the following claims addressing subject matter in application serial number 10/176,335:

35. (Added) A low dielectric constant polymer, comprising:
at least one thermosetting monomer having the structure



wherein Y is selected from a cage compound and a silicon atom, and R₁, R₂, R₃, and R₄ are independently selected from an aryl, a branched aryl and an arylene ether, and wherein at least one of the aryl, the branched aryl, and the arylene ether has a triple bond that participates to form at least part of the polymer.